

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE30H32VD uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =30V ,I_D =320A

 $R_{DS(ON)}$ < 1.6m Ω @ V_{GS} =10V

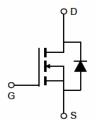
 $R_{DS(ON)} < 2.4 m\Omega @ V_{GS} = 4.5 V$

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

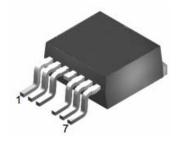
100% UIS TESTED! 100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-263-7L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30H32VD	NCE30H32VD	TO-263-7L	-	-	-

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V	
Gate-Source Voltage	V _G S	±20	V	
Drain Current-Continuous (Silicon Limited)	I _D	320	А	
Drain Current-Continuous(T _C =100°C) (Silicon Limited)	I _D (100℃)	226	А	
Pulsed Drain Current	I _{DM}	1280	А	
Maximum Power Dissipation	P _D	320	W	
Derating factor		2.13	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	1600	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C	

NCE30H32VD

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	$R_{ heta JC}$	0.47	°C/W	
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Electrical Characteristics (T_A=25°C unless otherwise noted)

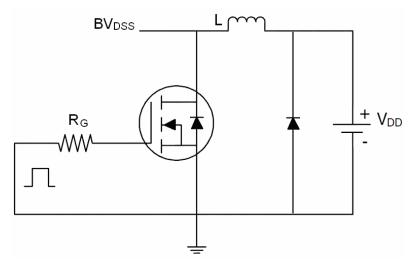
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	1.0	1.6	2.5	V
Drain Course On Ctate Desigtance	-	V _{GS} =10V, I _D =160A	-	1.2	1.6	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =160A	-	1.6	2.4	
Forward Transconductance	g FS	V _{DS} =5V,I _D =160A	50	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -45\/\/ -0\/	-	13873	-	PF
Output Capacitance	Coss	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	1672	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIDZ	-	1508	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	18	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =15 Ω ,	-	200	-	nS
Turn-Off Delay Time	$t_{d(off)}$	R_G =2.5 Ω , V_{GS} =10 V	-	85	-	nS
Turn-Off Fall Time	t _f		-	125	-	nS
Total Gate Charge	Qg		-	231	-	nC
Gate-Source Charge	Q_{gs}	I _D =160A,V _{DD} =15V,V _{GS} =10V	-	27.5	-	nC
Gate-Drain Charge	Q_{gd}		-	55	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =160A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	320	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, I _F = 160A	-	70		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	180		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+L			y LS+LD	

Notes:

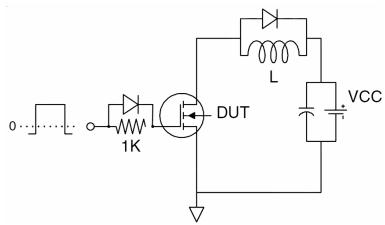
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=15V,V_G=10V,L=0.5mH,Rg=25 Ω

Test circuit

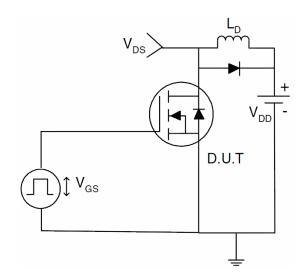
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:



Typical Electrical and Thermal Characteristics (Curves)

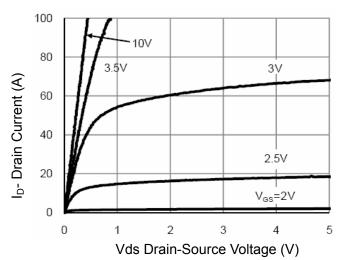


Figure 1 Output Characteristics

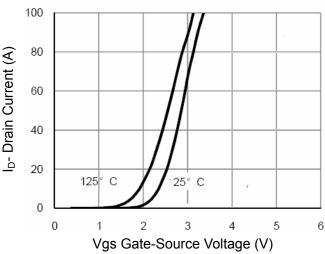


Figure 2 Transfer Characteristics

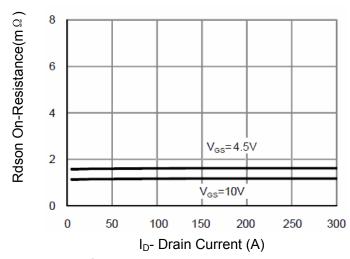


Figure 3 Rdson- Drain Current

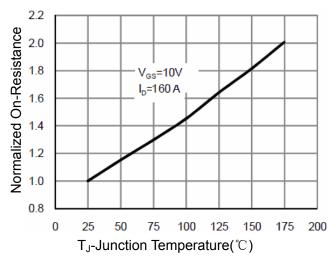


Figure 4 Rdson-JunctionTemperature

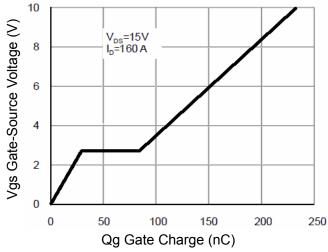


Figure 5 Gate Charge

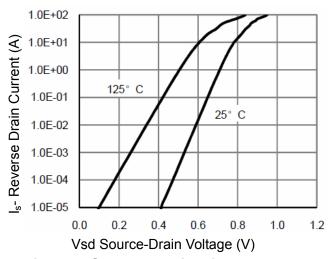


Figure 6 Source- Drain Diode Forward



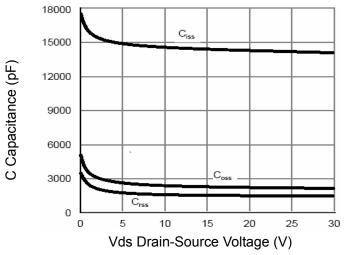


Figure 7 Capacitance vs Vds

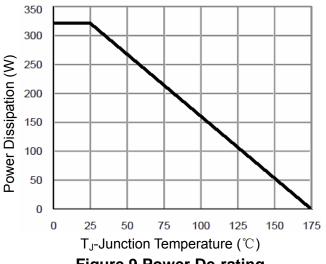


Figure 9 Power De-rating

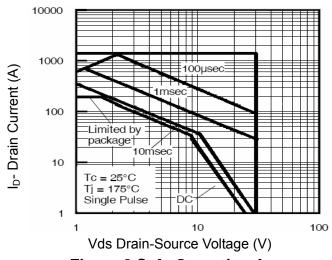


Figure 8 Safe Operation Area

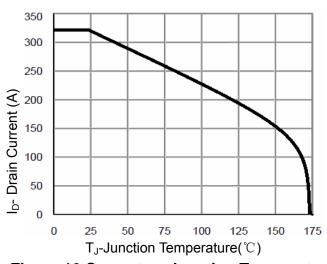
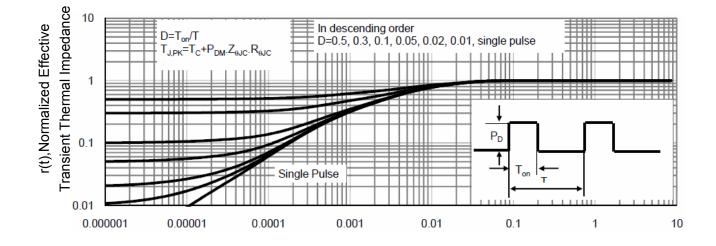
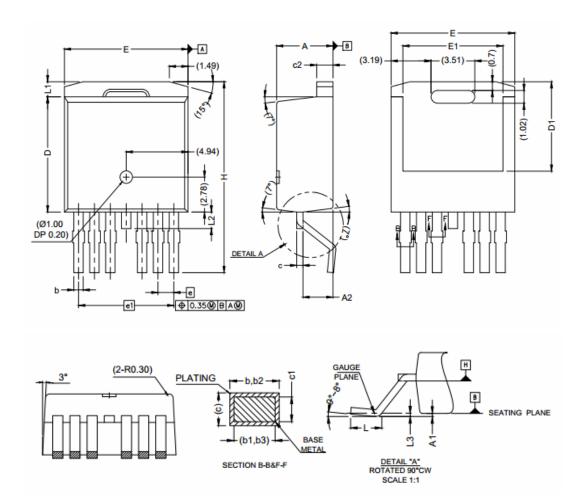


Figure 10 Current vs Junction Temperature



Square Wave Pluse Duration (sec) **Figure 11 Normalized Maximum Transient Thermal Impedance**

TO-263-7L Package Information



SYMBOL	MIN	MAX	
Α	4.30	4.70	
A1	-	0.254	
A2	2.20	2.60	
b	0.65	0.85	
b1	0.65	0.80	
b2	0.80	1.00	
b3	0.80	0.95	
С	0.45	0.60	
c1	0.45	0.55	
c2	1.25	1.40	
D	9.00	9.40	
D1	6.86	7.42	
E	9.68	10.08	
E1	7.70	8.30	
е	1.27 BSC		
e1	7.62 BSC		
L	1.78	2.79	
L1	-	1.60	
L2	-	1.78	
L3	0.25BSC		
Н	14.61	15.88	

http://www.ncepower.com

NCE30H32VD

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